

Application Serial No. 10/785,259  
Reply to office action of June 24, 2005

PATENT  
Docket: CU-3606

### Amendments To The Claims

The listing of claims presented below will replace all prior versions, and listings, of claims in the application.

#### Listing of claims:

1. (currently amended) A manufacturing method of a barrier-forming film comprising the steps of providing a vapor-deposited inorganic oxide ~~[[oxides]]~~ film on a face ~~[[side]]~~ of a substrate film, and applying an annealing treatment to the substrate film having said vapor-deposited inorganic film,

wherein said substrate film comprises a resinous film which selected from a group consisting of polyesters, polyamides and polypropylenes;  
and

wherein said annealing treatment comprises a heating treatment carried out at a temperature within the range from 55 °C to 150 °C in order to cause thermal shrinkage of the substrate film and to increase density of the vapor-deposited inorganic oxide film.

2. (canceled)

3. (currently amended) A manufacturing method of a barrier-forming film according to claim 1 ~~any one of claims 1 and 2~~, wherein said vapor-deposited inorganic oxide film comprises a vapor-deposited silicon oxide film or a vapor-deposited aluminum oxide film.

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4-5. (canceled)

6. (currently amended) A manufacturing method of a barrier-forming film according to claim 1 ~~any one of claims 1 to 5~~, wherein said heating treatment ~~annealing treatment~~ is carried out for a heating treatment time within a range of from 30 minutes to five days.

7. (canceled)